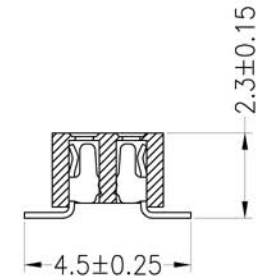
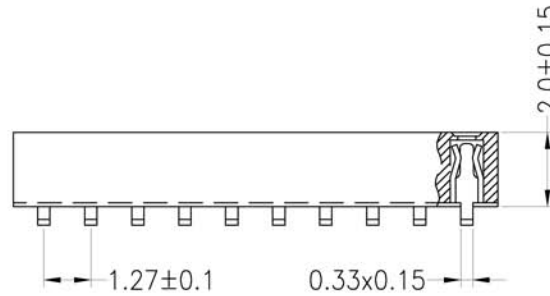
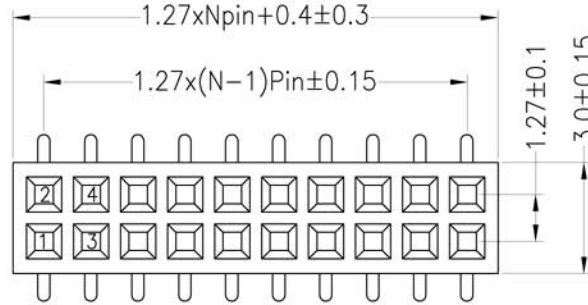
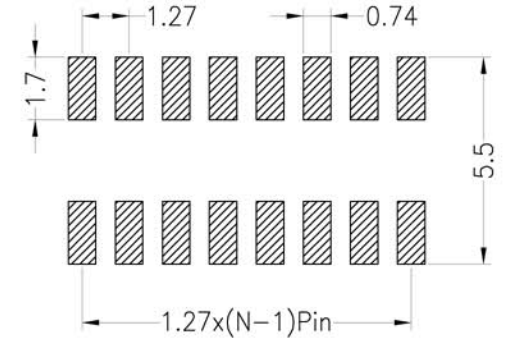


SPECIFICATIONS

Rated Current:1.0AMP
 Contact Resistance:20mΩ Max
 Withstand Voltage:500V AC/DC
 Insulation Resistance:1000MΩ Min
 Operation Temperature:-40°C to +105°C

Contact Material:Phosphor Bronze
 Contact Plating:Au Over Ni
 Insulator Material:Polyester(UL94V-0)
 Standard: PA6T
 Max.Processing Temp: 230°C for 30-60 seconds
 (260°C for 10 seconds)

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Ordering Information

2420 02 XX X N XX M U X 0X

- No.of Pins Per Row 2*50
- Insulator Material Option: C=BK-PA6T, E=BK-PA9T, F=BK-LCP
- Post: W=With Post, N=W/O Post
- Contact Plating: G1:Gold Flash, G2:1.5U" Gold, G3:2U" Gold, G4:3U" Gold, G5:5U" Gold, S0:Gold Flash/Tin, SN:Tin
- Packing: O=PE Bag, A=Tray, T=Tube, P=Tube+Cap, R=Reel+Cap, M=Reel+Mylar

				OPERATION		DRAW	BEN	12.04.18	SCALE	FIT	Lintronics Technology		
				X.X	±0.30				UNIT	mm			
				X.XX	±0.20	CHECK			SIZE	A4	PART NO.		242002XXXNXXMUX0X
				X.XXX	±0.10				SHEET	1/1	TITLE:		1.27PF 2xNPin H2.0 SMT
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL	APPROVE			PROJ.	